



# 20NM65

**Power MOSFET**

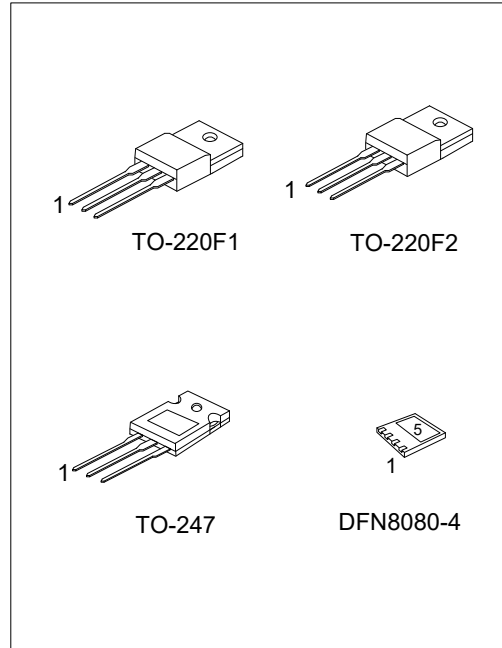
## 20A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

■ DESCRIPTION

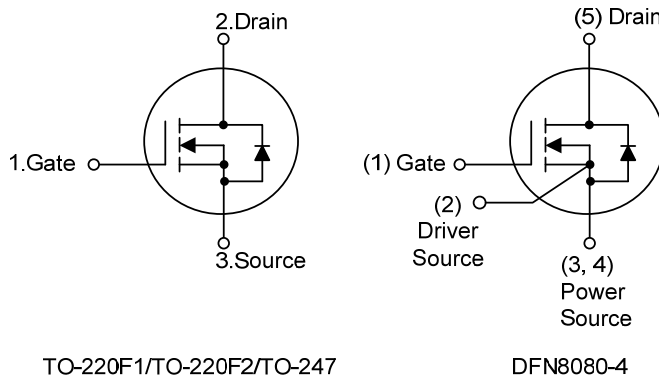
The **UTC 20NM65** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

■ FEATURES

- \*  $R_{DS(ON)} \leq 0.24 \Omega @ V_{GS}=10V, I_D=10A$
- \* By using Super Junction Structure
- \* Fast Switching
- \* With 100% Avalanche Tested



■ SYMBOL



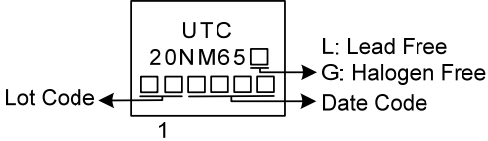
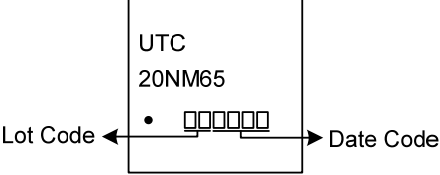
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment					Packing
Lead Free	Halogen Free		1	2	3	4	5	
20NM65L-TF1-T	20NM65G-TF1-T	TO-220F1	G	D	S	-	-	Tube
20NM65L-TF2-T	20NM65G-TF2-T	TO-220F2	G	D	S	-	-	Tube
20NM65L-T47-T	20NM65G-T47-T	TO-247	G	D	S	-	-	Tube
20NM65L-K04-8080-R	20NM65G-K04-8080-R	DFN8080-4	G	S	S	S	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>20NM65G-TF1-T</p>	<p>(1) T: Tube, R: Tape Reel                  (2) TF1: TO-220F1, TF2: TO-220F2, T47: TO-247                  K04-8080: DFN8080-4                  (3) G: Halogen Free and Lead Free, L: Lead Free</p>
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MARKING

TO-220F1 / TO-220F2 / TO-247	DFN8080-4
 <p>UTC 20NM65</p> <p>Lot Code →</p> <p>→ Date Code</p> <p>L: Lead Free G: Halogen Free</p> <p>1</p>	 <p>UTC 20NM65</p> <p>Lot Code →</p> <p>• → Date Code</p>

■ ABSOLUTE MAXIMUM RATINGS ( $T_c=25^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	650	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Continuous Drain Current	Continuous	$I_D$	20	A
Pulsed Drain Current	Pulsed (Note 2)	$I_{DM}$	40	A
Avalanche energy	Single Pulsed (Note 3)	$E_{AS}$	265	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.8	V/nS
Power Dissipation	TO-220F1/TO-220F2	$P_D$	34	W
	TO-247		130	W
	DFN8080-4		63.5	W
Junction Temperature		$T_J$	+150	$^{\circ}\text{C}$
Storage Temperature Range		$T_{STG}$	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L=30\text{mH}$ ,  $I_{AS}=4.2\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J = 25^{\circ}\text{C}$

4.  $I_{SD} \leq 10\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^{\circ}\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F1/TO-220F2	$\theta_{JA}$	62.5	$^{\circ}\text{C}/\text{W}$
	TO-247		40	$^{\circ}\text{C}/\text{W}$
	DFN8080-4		35 (Note)	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220F1/TO-220F2	$\theta_{JC}$	3.67	$^{\circ}\text{C}/\text{W}$
	TO-247		0.96	$^{\circ}\text{C}/\text{W}$
	DFN8080-4		1.95 (Note)	$^{\circ}\text{C}/\text{W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

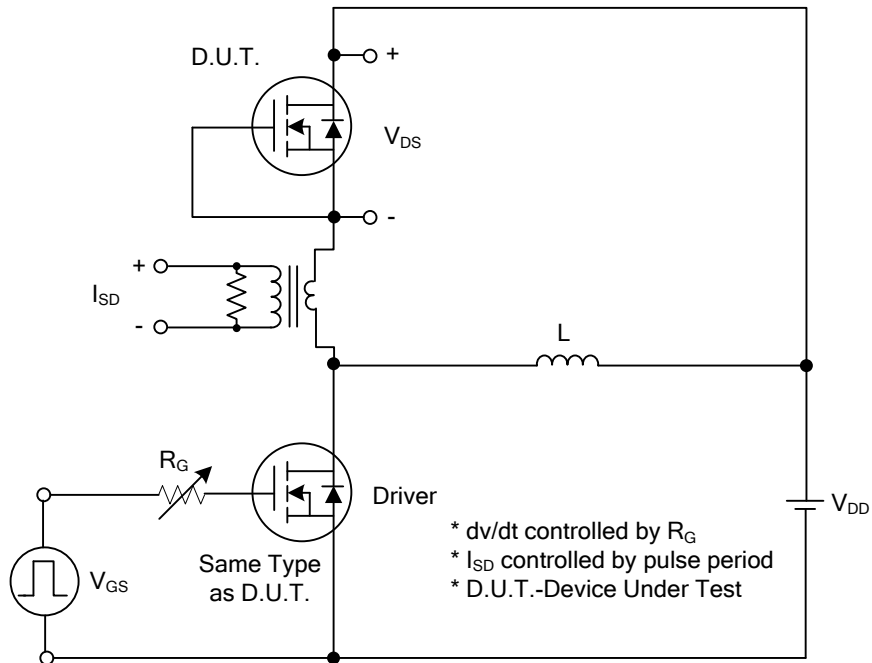
■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub> =25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	650			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V			10	μA
Gate-Source Leakage Current	Forward	V <sub>DS</sub> =0V, V <sub>GS</sub> =+30V			+100	nA
	Reverse		V <sub>DS</sub> =0V, V <sub>GS</sub> =-30V			-100
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA	2.5		4.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A			0.24	Ω
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =50V, f=1.0MHz		1300		pF
Output Capacitance	C <sub>OSS</sub>			145		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			5		pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge (Note 1)	Q <sub>G</sub>	V <sub>DS</sub> =520V, V <sub>GS</sub> =10V, I <sub>D</sub> =20A (Note 1, 2)		47		nC
Gate to Source Charge	Q <sub>GS</sub>			12		nC
Gate to Drain Charge	Q <sub>GD</sub>			20		nC
Turn-on Delay Time (Note 1)	t <sub>D(ON)</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =10V, I <sub>D</sub> =20A, R <sub>G</sub> =25Ω (Note 1, 2)		20		ns
Rise Time	t <sub>R</sub>			28		ns
Turn-off Delay Time	t <sub>D(OFF)</sub>			146		ns
Fall-Time	t <sub>F</sub>			57		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Pulsed Current	I <sub>S</sub>				20	A
Drain-Source Diode Forward Voltage (Note 1)	I <sub>SM</sub>				40	A
Maximum Body-Diode Continuous Current	V <sub>SD</sub>	I <sub>S</sub> =20A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =20A, V <sub>GS</sub> =0V, dI/dt=100A/μs		421		ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>				7.5	

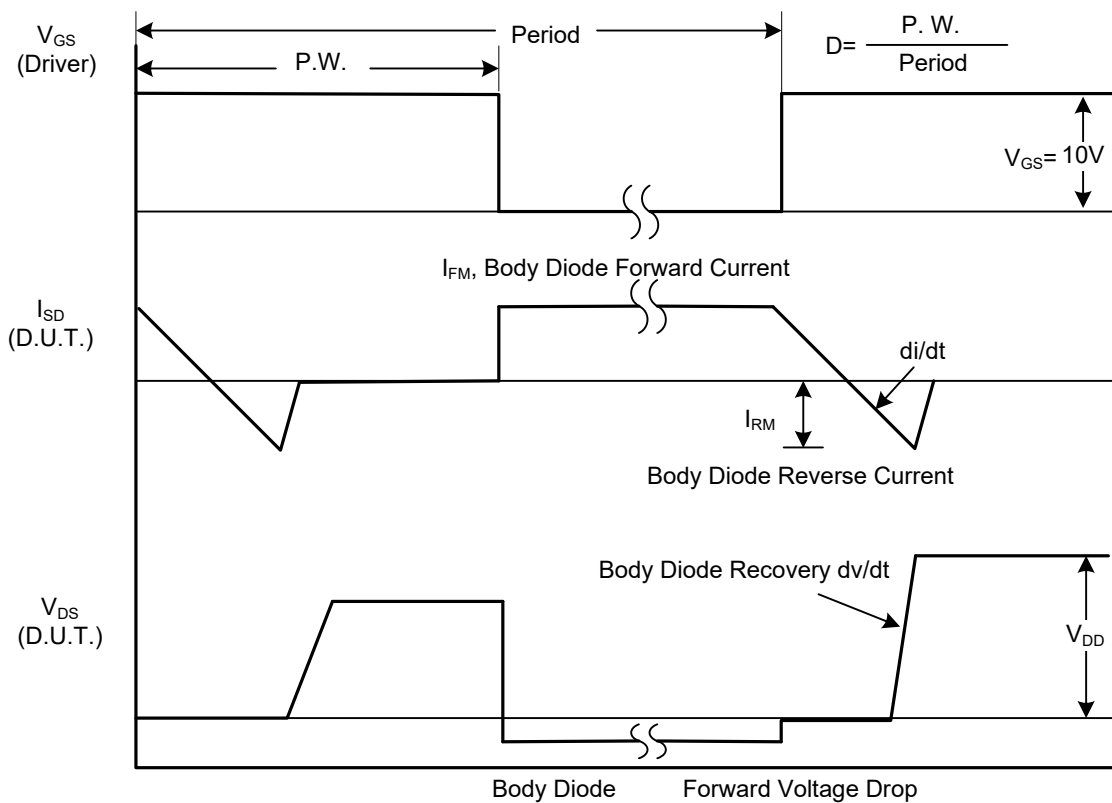
Note: 1. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

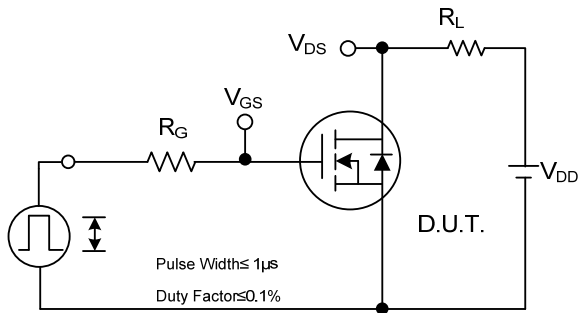


Peak Diode Recovery dv/dt Test Circuit

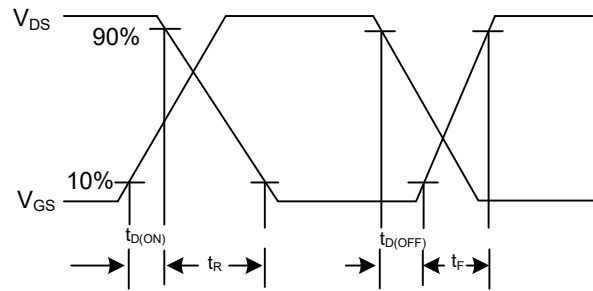


Peak Diode Recovery dv/dt Waveforms

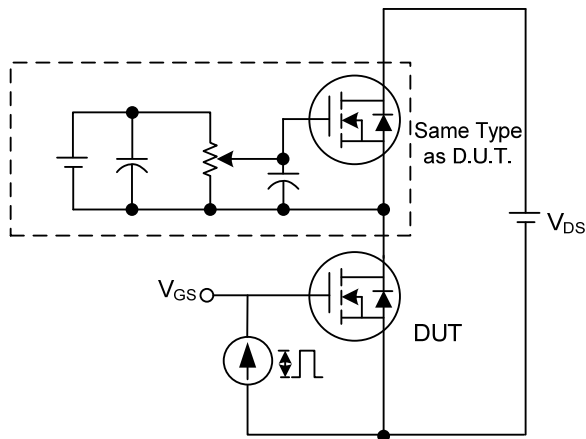
## TEST CIRCUITS AND WAVEFORMS



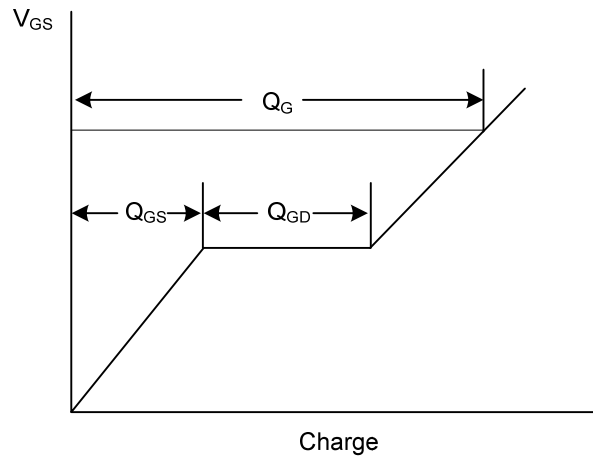
**Switching Test Circuit**



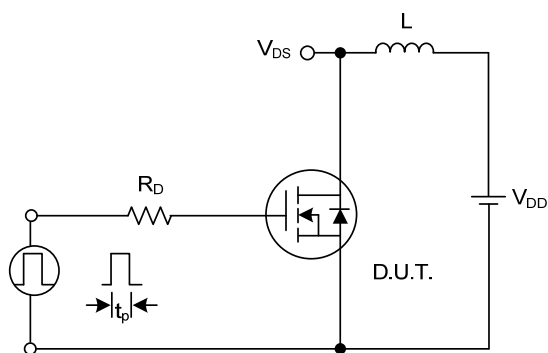
**Switching Waveforms**



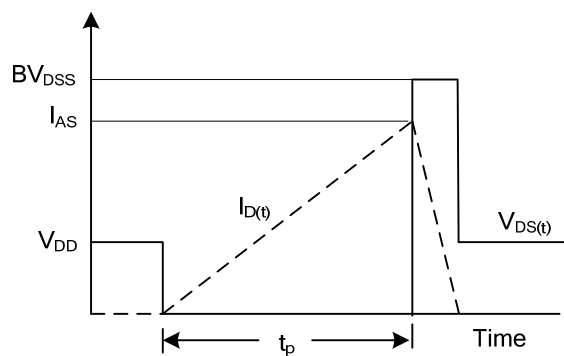
**Gate Charge Test Circuit**



**Gate Charge Waveform**

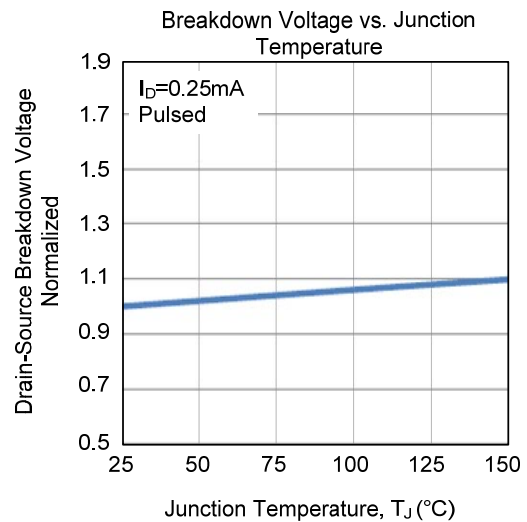
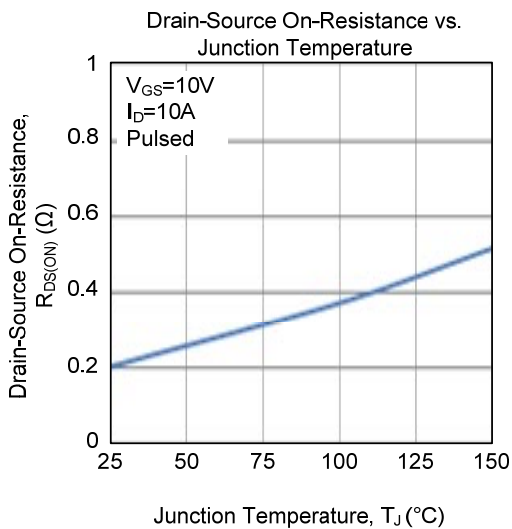
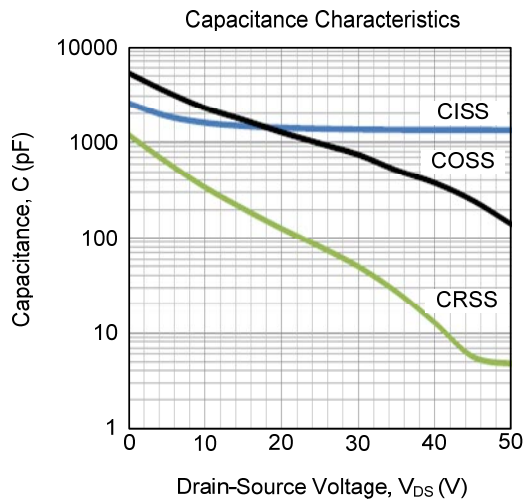
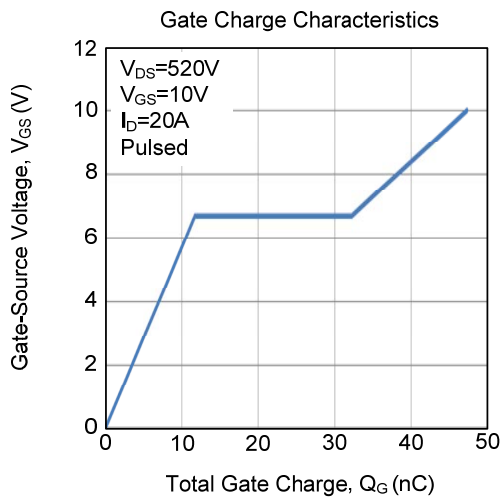
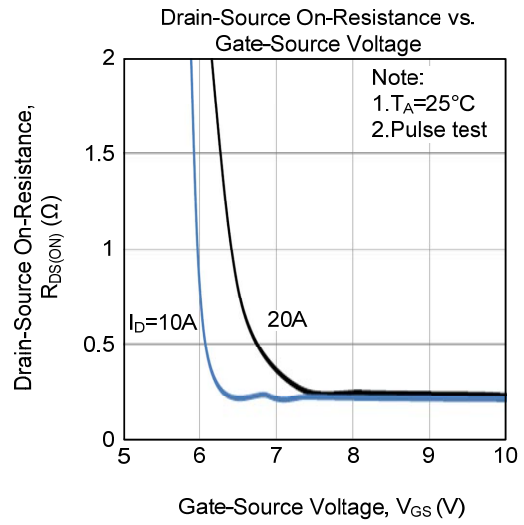
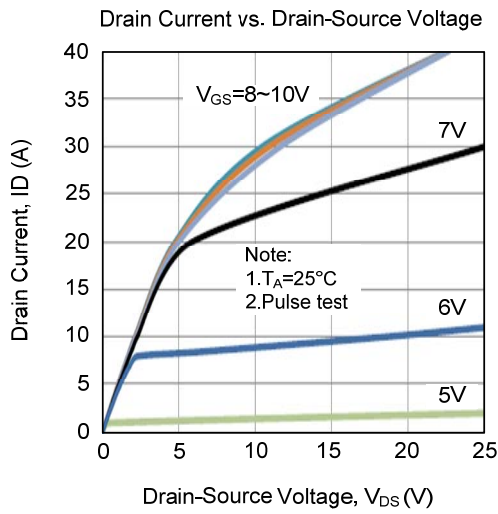


**Unclamped Inductive Switching Test Circuit**

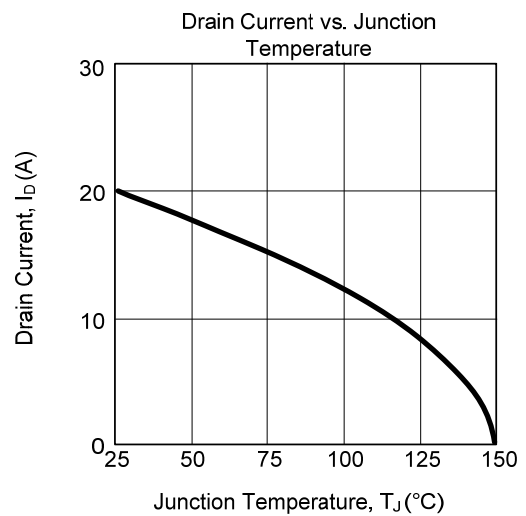
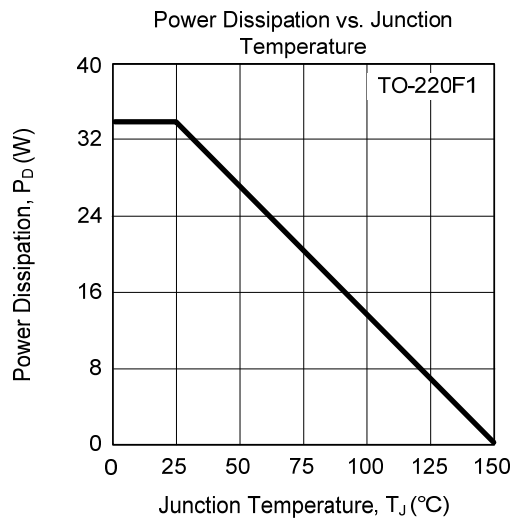
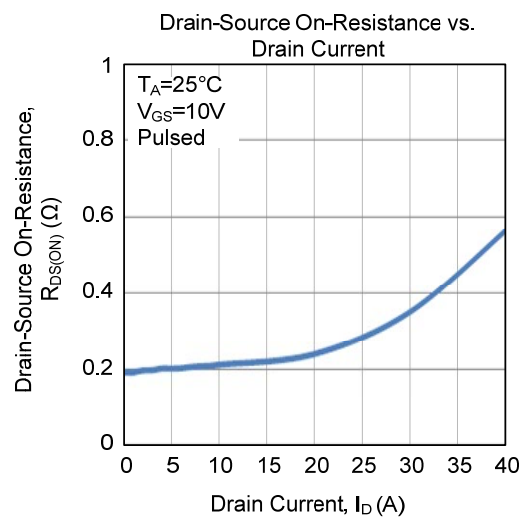
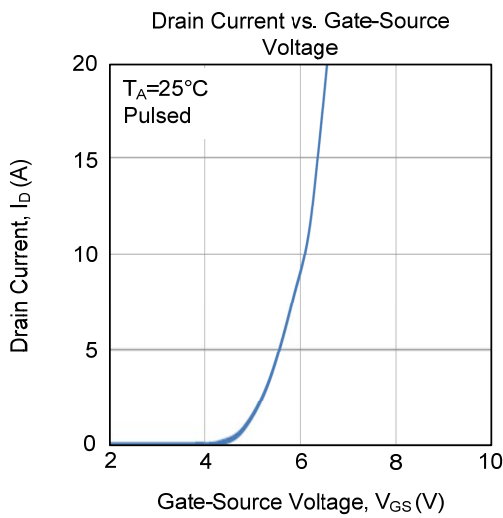
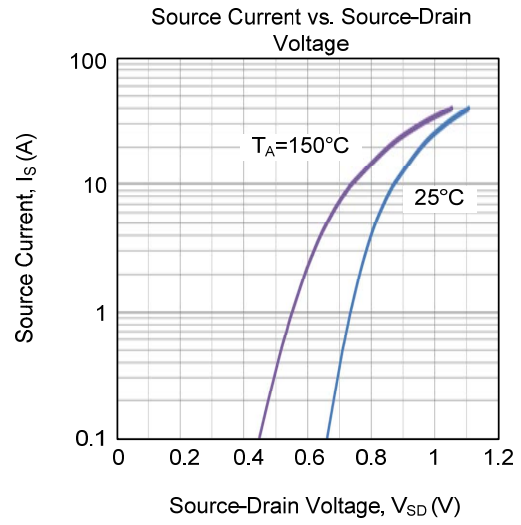
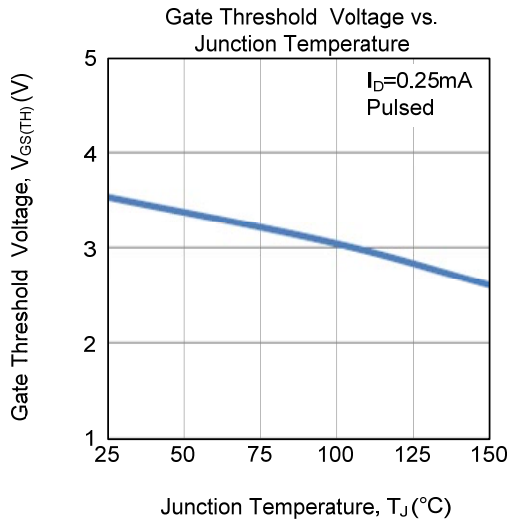


**Unclamped Inductive Switching Waveforms**

## TYPICAL CHARACTERISTICS

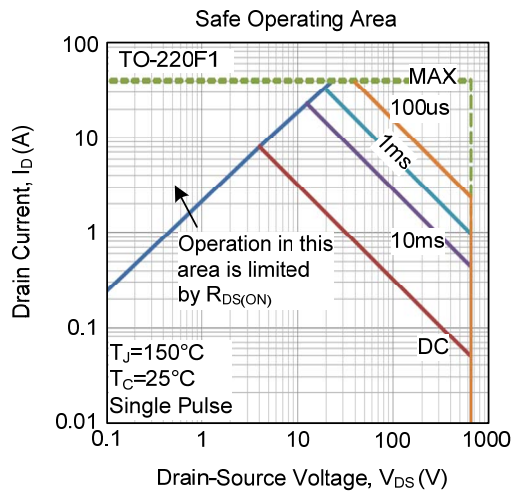


## ■ TYPICAL CHARACTERISTICS (Cont.)





■ TYPICAL CHARACTERISTICS (Cont.)



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